

Apr.2011

Dear customer



Invitation to JPCA Show 2011

We run booth at JPCA Show 2011 at Tokyo Big Sight from June 1st to 3rd 2011.

We believe you would be interested in Electronic Circuits and we would like to invite you to attend.

TOKYO KAKOKI CO.,LTD. of our group businesses also run booth at JPCA Show 2011. We would be delighted if you could arrange your schedule and take the opportunity to visit our booth and the show.

Dates : June 1st [Wed] – 3rd [Fri], 2011

Open Hours : 10:00~17:00

Venue : Tokyo Big Sight, Japan / East Hall 2 2E-02

« Exhibit Products »

	Application
1	Acid Copper Plating for Via Filling and for Flexible Circuits
2	Low-cost Catalyst Bath for Electroless Copper Plating Process
3	Seed Layer Etching Process
4	Environment-responsive Products
5	Brightener for Electronic Silver Plating

« NPI presentation (charge free) »

Title Low-cost Catalyst Bath for Electroless Copper Plating Process

Date June 3rd(Fri), 11:30~12:00

Place East Hall 2, Conference room E

Application Please apply to the following mail address in advance.

(Since a limitation is in the number of seats, please apply earlier.)

MELTEX INC	Kyowa Bldg., 2-28-5, Higashi Nihonbashi, Chuo-ku, Tokyo 103-0004		
	TEL.+81-3-3865-0175	FAX. +81-3-3865-0174	E-mail:sales@meltex.co.jp
Sales section 1,2	TEL.+81-48-665-2107	Overseas Section	TEL.+81-48-665-2114
Tohoku Sales Office	TEL.+81-22-295-7040	Taiwan Office	TEL.+886-34020500
Nagoya Sales Office	TEL.+81-52-211-6274	Meltex (HK) Ltd	TEL.+852-24208938
Osaka Sales Office	TEL.+81-6-6943-5683	Shenzhen Office	TEL.+86-755-82300121
Kyushu Sales Office	TEL.+81-92-472-2861	Malaysia Office	TEL.+60-3-2092-9497